

N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent RDS(ON) with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

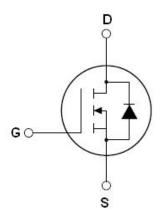
Features

- New technology for high voltage device
- Low on-resistance and low conduction losses
- Small package
- Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V _{DS}	650	V
R _{DS(ON)} MAX	190	mΩ
I_D	21	A



Schematic diagram

Package Marking And Ordering Information

Device	Device Package	Marking
NCE65T180	TO-220	NCE65T180
NCE65T180F	TO-220F	NCE65T180F
NCE65T180D	TO-263	NCE65T180D



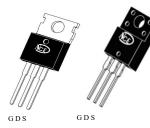


Table 1. Absolute Maximum Ratings (T_c=25℃)

TO-263 TO-220 TO-220F

Parameter	Symbol	NCE65T180 NCE65T180D	NCE65T180F	Unit
Drain-Source Voltage (Vgs=0V)	V _{DS}	6	50	V
Gate-Source Voltage (V _{DS} =0V), AC (f>1 Hz)	Vgs	±	30	V
Continuous Drain Current at T _C =25°C	I _{D (DC)}	21	21*	Α
Continuous Drain Current at T _C =100°C	I _{D (DC)}	13.2	13.2*	Α
Pulsed drain current (Note 1)	I _{DM (pluse)}	84	84*	Α
Maximum Power Dissipation(T _C =25 °C)	P _D	188	33.8	W
Derate above 25°C		1.5	0.27	W/°C
Single pulse avalanche energy (Note 2)	Eas	441		mJ
Avalanche current ^(Note 1)	I _{AR}	10.5		Α
Repetitive Avalanche energy , t_{AR} limited by T_{Jmax} (Note 1)	E _{AR}	0.7		mJ



Parameter	Symbol	NCE65T180 NCE65T180D	NCE65T180F	Unit
Drain Source voltage slope, V _{DS} ≤480 V,	dv/dt	50		V/ns
Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub>	dv/dt	1	5	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55	+150	°C

^{*} limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	NCE65T180 NCE65T180D	NCE65T180F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R_{thJC}	0.66	3.69	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R_{thJA}	62.5	80	°C /W

Table 3. Electrical Characteristics (TA=25°Cunless otherwise noted)

Parameter	Symbol	Symbol Condition		Тур	Max	Unit
On/off states	<u></u>	1	1		ı	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V		0.05	1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			100	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3	3.5	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =10.5A		150	190	mΩ
Dynamic Characteristics						
Forward Transconductance	G FS	V _{DS} = 20V, I _D = 10.5A		16		S
Input Capacitance	C _{lss}	\/ -50\/\/ -0\/		2250		PF
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V, F=1.0MHz		83		PF
Reverse Transfer Capacitance	C _{rss}	F-1.UIVIDZ		1.6		PF
Total Gate Charge	Qg	\/ -400\/ -244		36		nC
Gate-Source Charge	Q _{gs}	V _{DS} =480V,I _D =21A, V _{GS} =10V		14		nC
Gate-Drain Charge	Q_{gd}	VGS-10V		8.5		nC
Switching times						
Turn-on Delay Time	t _{d(on)}			11		nS
Turn-on Rise Time	tr	V_{DD} =380 V , I_{D} =11 A ,		6		nS
Turn-Off Delay Time	t _{d(off)}	$R_G=4\Omega,V_{GS}=10V$		61		nS
Turn-Off Fall Time	t _f			4.5		nS
Source- Drain Diode Characteristics						
Source-drain current(Body Diode)	I _{SD}	T -25°C			21	Α
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			84	Α
Forward on voltage	V _{SD}	T _j =25°C,I _{SD} =21A,V _{GS} =0V		0.9	1.3	V
Reverse Recovery Time	t _{rr}			310		nS
Reverse Recovery Charge	Qrr	T _j =25°C,I _F =21A,di/dt=100A/μs		5		uC
Peak Reverse Recovery Current	I _{rrm}			28		Α

 $Notes\ 1. \\ Repetitive\ Rating:\ Pulse\ width\ limited\ by\ maximum\ junction\ temperature$

^{2.} T_j =25°C, V_{DD} =50V, V_G =10V, R_G =25 Ω



10⁻²

NCE65T180D,NCE65T180,NCE65T180F

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Safe operating area for TO-220/TO-263

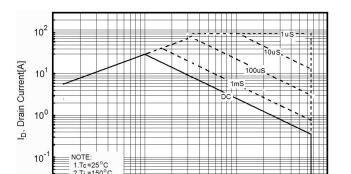


Figure 3. Source-Drain Diode Forward Voltage

V_{DS}, Drain-Source Voltage[V]

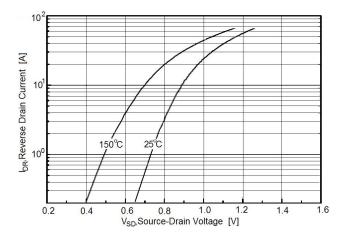


Figure 5. Transfer characteristics

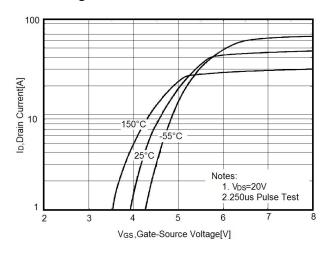


Figure 2. Safe operating area for TO-220F

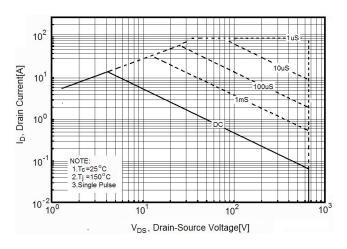


Figure 4. Output characteristics

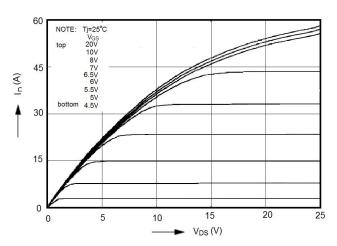


Figure 6. Static drain-source on resistance

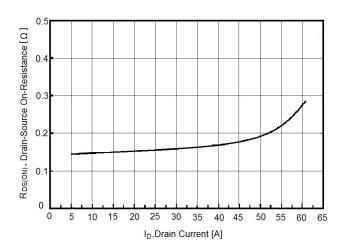




Figure 7. R_{DS(ON)} vs Junction Temperature

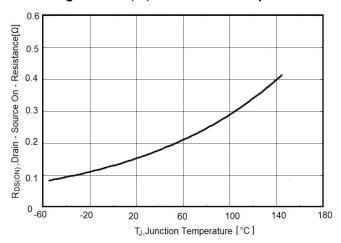


Figure 8. BV_{DSS} vs Junction Temperature

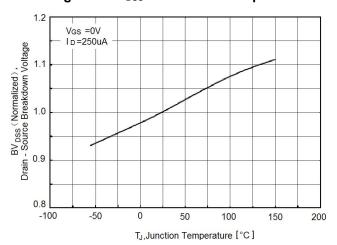


Figure 9. Maximum $I_{\mbox{\scriptsize D}}$ vs Junction Temperature

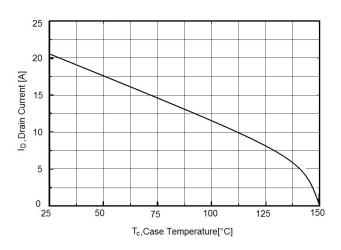


Figure 10. Transient Thermal Impedance for TO-220

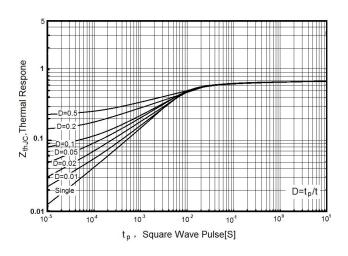


Figure 11. Transient Thermal Impedance for TO-220F

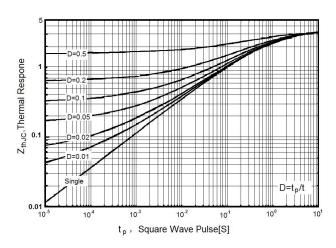


Figure 12. Gate charge waveforms

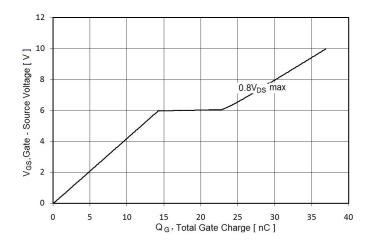
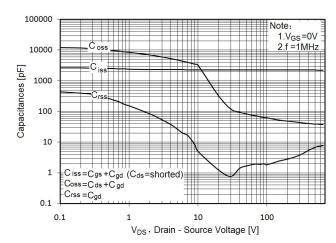




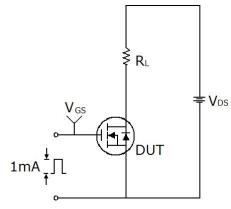
Figure 13. Capacitance

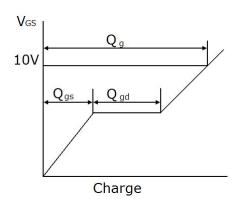




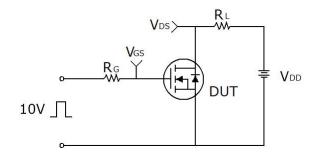
Test circuit

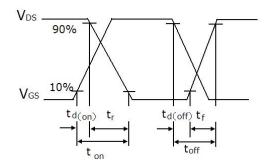
1) Gate charge test circuit & Waveform



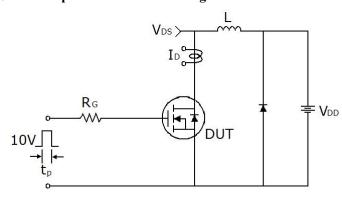


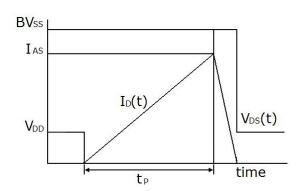
2) Switch Time Test Circuit:





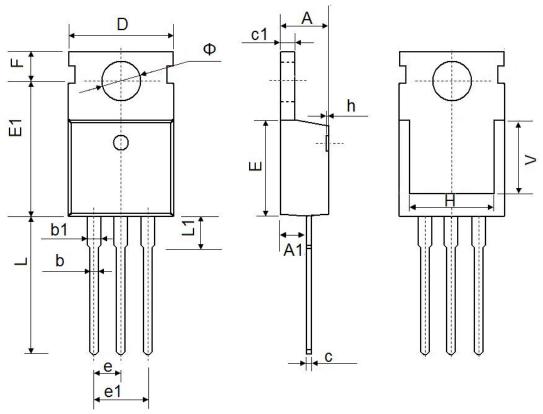
3) Unclamped Inductive Switching Test Circuit & Waveforms







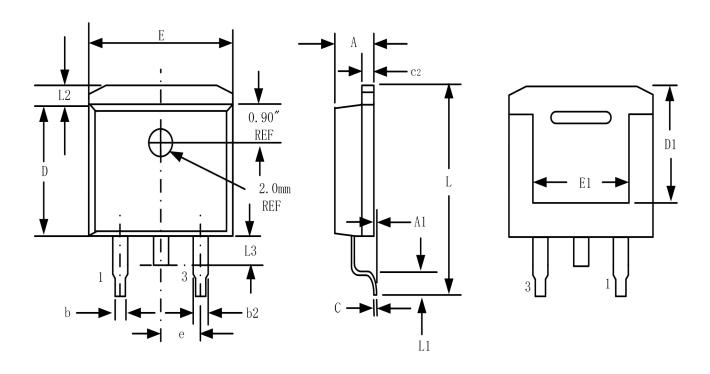
TO-220-3L-C Package Information



Complete	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540	TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500	REF.	0.295	REF.	
Ф	3.400	3.800	0.134	0.150	



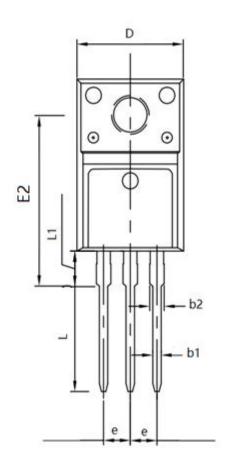
TO-263 Package Information

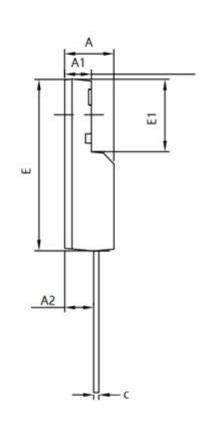


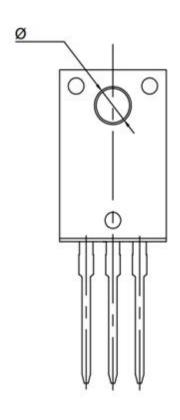
Symbol	Dimensions	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	4.32	4.57	0.170	0.180	
A1	-	0.25		0.010	
b	0.71	0.94	0.028	0.037	
b2	1.15	1.40	0.045	0.055	
С	0.46	0.61	0.018	0.024	
c2	1.22	1.40	0.048	0.055	
D	8.89	9.40	0.350	0.370	
D1	8.01	8.23	0.315	0.324	
Е	10.04	10.28	0.395	0.405	
E1	7.88	8.08	0.310	0.318	
е	2.54	BSC	0.100	BSC	
L	14.73	15.75	0.580	0.620	
L1	2.29	2.79	0.090	0.110	
L2	1.15	1.39	0.045	0.055	
L3	1.27	1.77	0.050	0.070	



TO-220F Package Information







Symbol	Dimensions I	Dimensions In Millimeters		ns In Inches	
	Min.	Max.	Min.	Max.	
А	4.500	4.900	0.177	0.193	
A1	2.340	2.740	0.092	0.108	
A2	2.560	2.960	0.101	0.117	
b1	0.700	0.900	0.028	0.035	
b2	1.180	1.580	0.046	0.062	
С	0.400	0.600	0.016	0.024	
D	9.960	10.360	0.392	0.408	
E	15.670	15.970	0.617	0.629	
E1	6.500	6.900	0.256	0.272	
E2	15.500	16.100	0.610	0.634	
е	2.540	2.540 TYP		TYP	
Ф	3.080	3.280	0.121	0.129	
L	12.640	13.240	0.498	0.521	
L1	3.030	3.430	0.119	0.135	



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